

RoHS

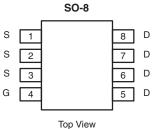
COMPLIANT

HALOGEN FREE

Vishay Siliconix

N-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	$\mathbf{R}_{DS(on)}$ (Ω) \mathbf{I}_{D} (A) ^a \mathbf{Q}_{g}				
100	0.0088 at V _{GS} = 10 V	20	18.3 nC			
100	0.012 at V _{GS} = 4.5 V	17	10.5 110			

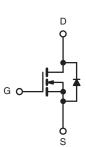


FEATURES

- Halogen-free According to IEC 61249-2-21 • Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested
 Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- DC/DC Primary Side Switch
- Telecom/Server
- Industrial



Ordering Information: Si4190DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C		20		
	T _C = 70 °C		16		
	T _A = 25 °C		13.4 ^{b, c}		
	T _A = 70 °C		10.6 ^{b, c}		
Pulsed Drain Current		I _{DM}	70	A	
Continuous Source-Drain Diode Current	T _C = 25 °C		7.0		
	T _A = 25 °C	- I _S	3.1 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	30		
Avalanche Energy	L = 0.1 mm	E _{AS}	45	mJ	
Maximum Power Dissipation	T _C = 25 °C		7.8		
	T _C = 70 °C		5.0	w	
	T _A = 25 °C	P _D	3.5 ^{b, c}	VV	
	T _A = 70 °C	1	2.2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	29	35	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	13	16		
Notes:					•	

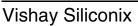
a. Based on $T_C = 25$ °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 80 °C/W.

Si4190DY





Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		·					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	100			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050		47		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = 250 μΑ		- 5.8			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.2		2.8	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	1 10 μΑ	
		V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 55 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			А	
Drain-Source On-State Resistance ^a	В	V _{GS} = 10 V, I _D = 15 A		0.0073	0.0088	Ω	
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		0.0093	0.0120		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		58		S	
Dynamic ^b		•					
Input Capacitance	C _{iss}			2000		pF	
Output Capacitance	C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		1120			
Reverse Transfer Capacitance	C _{rss}	1		56			
Total Gate Charge		$V_{DS} = 50$ V, $V_{GS} = 10$ V, $I_{D} = 10$ A		38.6	58	nC	
Iolai Gale Charge				18.3	28		
Gate-Source Charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		5.4			
Gate-Drain Charge	Q _{gd}			7.3			
Gate Resistance	R _g	f = 1 MHz	0.6	2.7	5.4	Ω	
Turn-On Delay Time	t _{d(on)}			12	24	- ns	
Rise Time	t _r	V_{DD} = 50 V, R_L = 5 Ω		13	26		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10$ A, $V_{GEN} = 7.5$ V, $R_g = 1$ Ω		40	70		
Fall Time	t _f			11	22		
Turn-On Delay Time	t _{d(on)}			10	20		
Rise Time	t _r	V_{DD} = 50 V, R_L = 5 Ω		10	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10$ A, $V_{GEN} = 10$ V, $R_g = 1$ Ω		40	70		
Fall Time	t _f]		11	22		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			7.0		
Pulse Diode Forward Current ^a	I _{SM}				70	A	
Body Diode Voltage	V _{SD}	I _S = 5 A		0.75	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			51	100	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	$\frac{1}{1}$		51	100	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		24		- ns	
Reverse Recovery Rise Time	t _b	1		27			

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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- 55 °C

4

5

3

 $\mathrm{C}_{\mathrm{iss}}$

C_{oss}

60

Capacitance

80

 $V_{GS} = 10 V$

- V_{GS} = 4.5 V

125 150

100

40

25

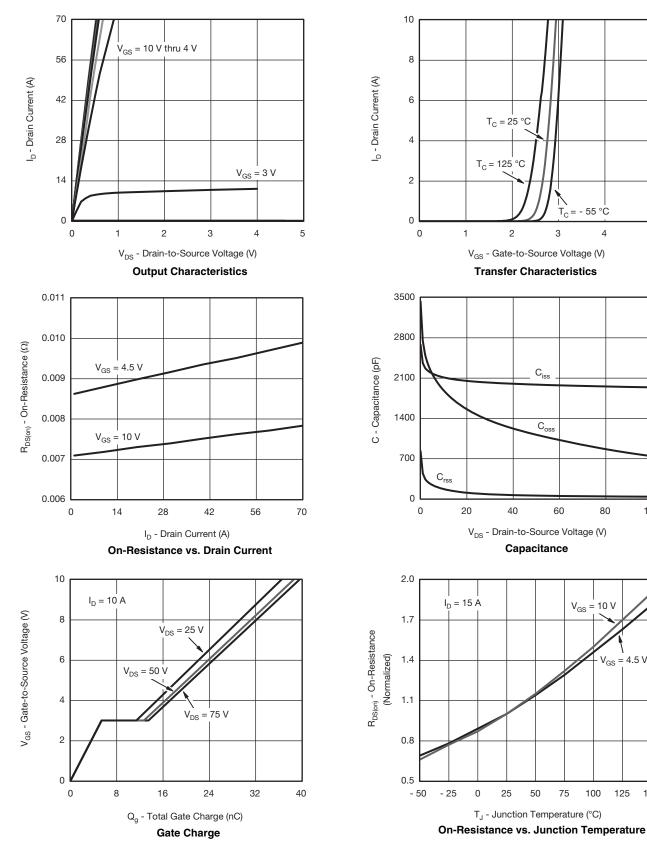
50

75

100

2

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

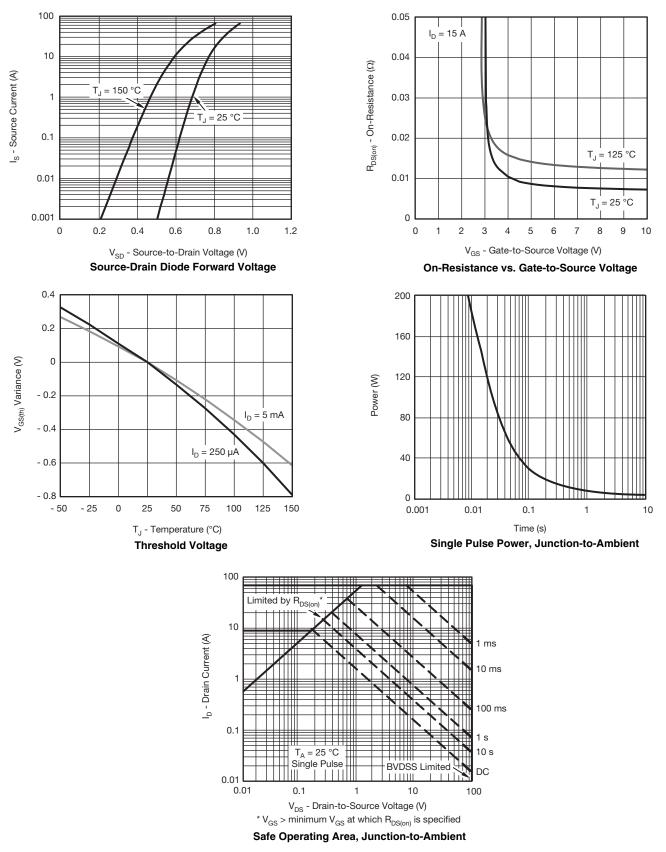


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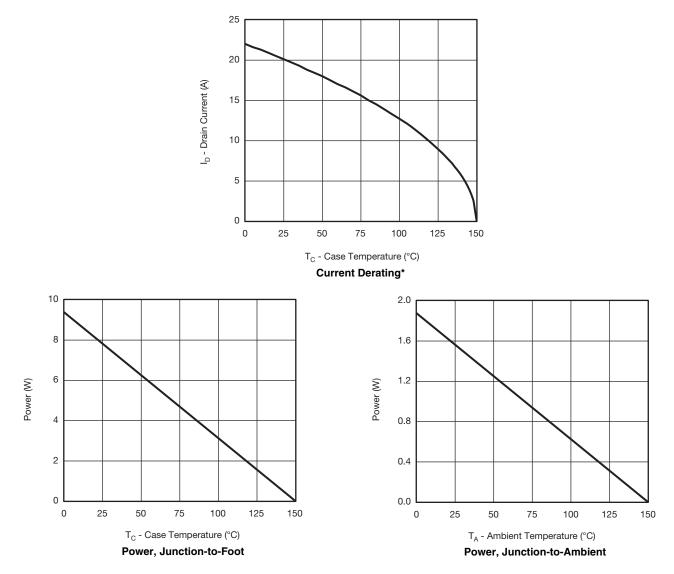


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





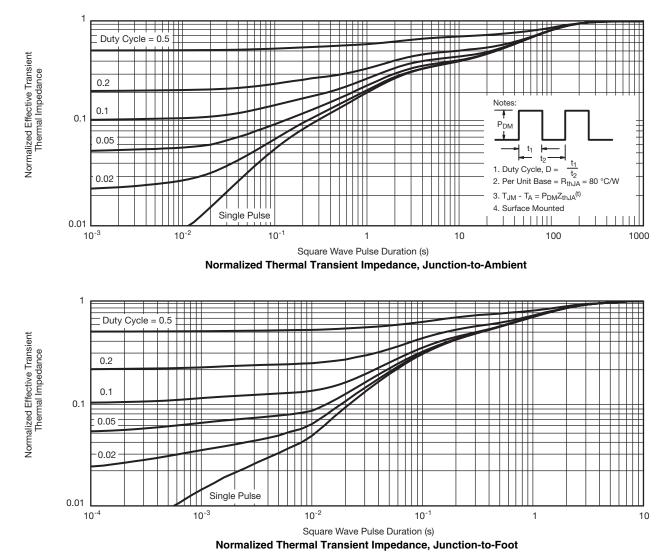
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?66595.



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